

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 7,059,948 B2  
APPLICATION NO. : 10/026854  
DATED : June 13, 2006  
INVENTOR(S) : Li et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page, Item (75), Inventors: Please change "Llang-Yuh" to --Liang-Yuh--

Title Page, Item (56), References Cited, U.S. PATENT DOCUMENTS: Please include the following reference:

--5,328,716                      7/1994                      Buchanan--

Column 2, Lines 4-5: Change "substra The polishing pressure preferably has e next." to --substrate to the next.--

Column 6, Line 46: After "from", change "and" to --any--

Column 7, Line 64: Change "C<sub>6</sub>H<sub>12</sub>Na<sub>2</sub>O<sub>6</sub>S<sub>4</sub>" to --C<sub>6</sub>H<sub>12</sub>Na<sub>2</sub>O<sub>6</sub>S<sub>4</sub>--

Column 10, Line 35: Delete "between"

Column 10, Line 41: Change "my" to --may--

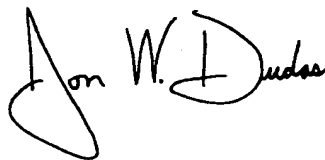
Column 11, Line 1: Change "Modem" --Modern--

Column 12, Line 17: Change "supporting" to --support--

Column 12, Line 57: Delete "may be utilized"

Signed and Sealed this

Sixteenth Day of January, 2007



JON W. DUDAS  
*Director of the United States Patent and Trademark Office*